

HAT1024R

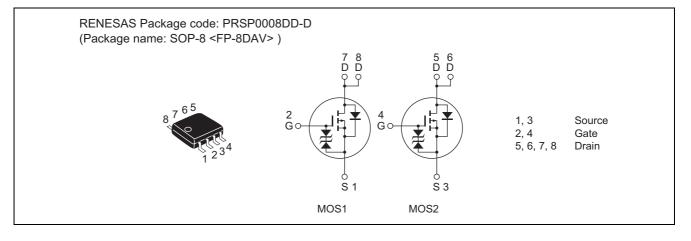
Silicon P Channel Power MOS FET High Speed Power Switching

> REJ03G1146-0900 (Previous: ADE-208-476G) Rev.9.00 Sep 07, 2005

Features

- Low on-resistance
- Capable of 4 V gate drive
- Low drive current
- High density mounting

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	-30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	-3.5	А
Drain peak current	I _{D (pulse)} Note 1	-28	А
Body-drain diode reverse drain current	I _{DR}	-3.5	А
Channel dissipation	Pch Note 2	2	W
Channel dissipation	Pch Note 3	3	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. 1 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

3. 2 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

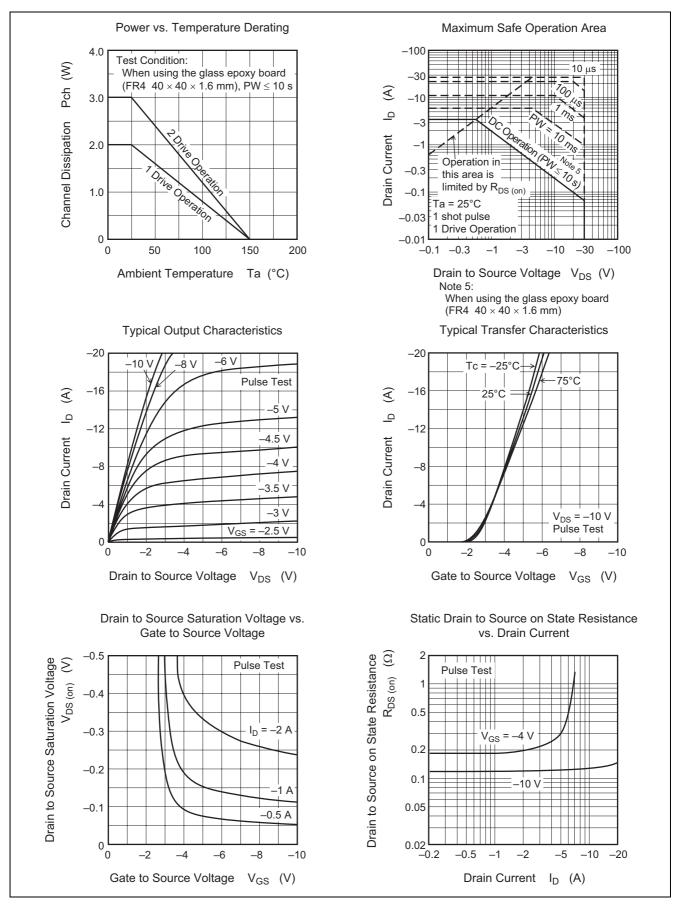
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-30			V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20			V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}			±10	μΑ	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}			-10	μΑ	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	-1.0		-2.5	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}		0.12	0.16	Ω	$I_D = -2 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note 4}}$
	R _{DS (on)}		0.2	0.34	Ω	$I_D = -2 A, V_{GS} = -4 V^{Note 4}$
Forward transfer admittance	y _{fs}	2.5	3.5		S	$I_D = -2 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss		350		pF	V _{DS} = -10 V
Output capacitance	Coss		230		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		75		pF	f = 1 MHz
Turn-on delay time	t _{d (on)}		18		ns	$V_{GS} = -4 V, I_D = -2 A,$
Rise time	tr		110		ns	$V_{DD} \cong -10 \text{ V}$
Turn-off delay time	t _{d (off)}		20		ns	
Fall time	t _f		30		ns	
Body-drain diode forward voltage	V _{DF}		-1.0	-1.5	V	$I_F = -3.5 \text{ A}, V_{GS} = 0^{Note 4}$
Body-drain diode reverse recovery time	t _{rr}	—	60		ns	$I_F = -3.5 \text{ A}, V_{GS} = 0$
						di _F /dt = 20 A/µs

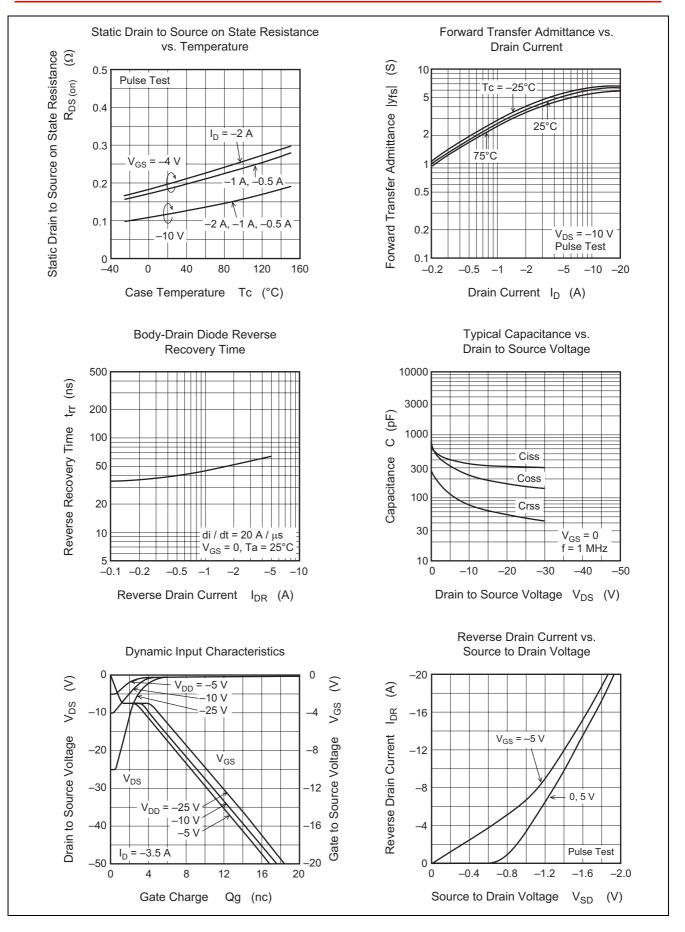
Note: 4. Pulse test



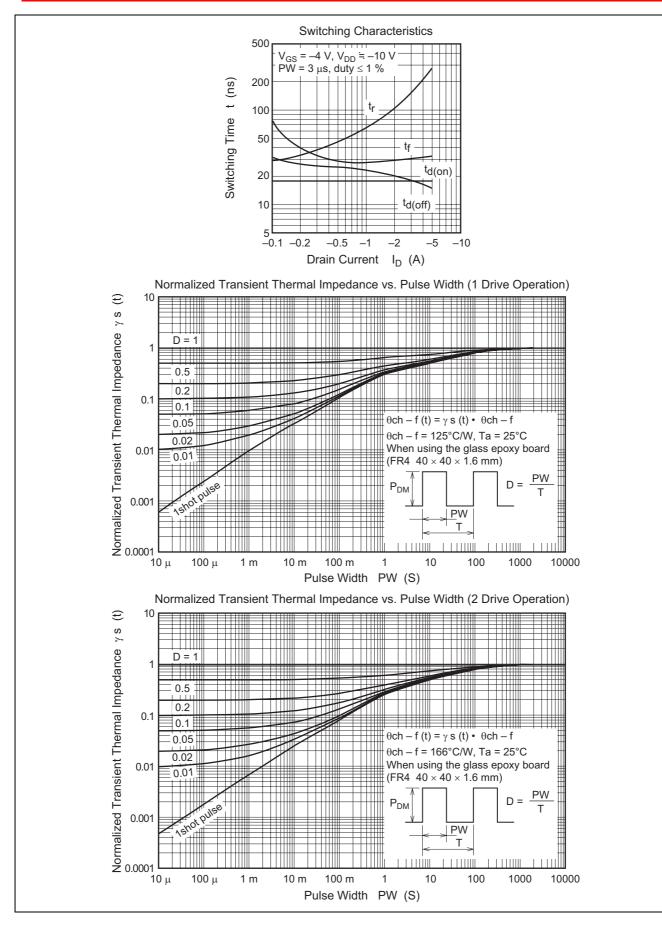
Main Characteristics



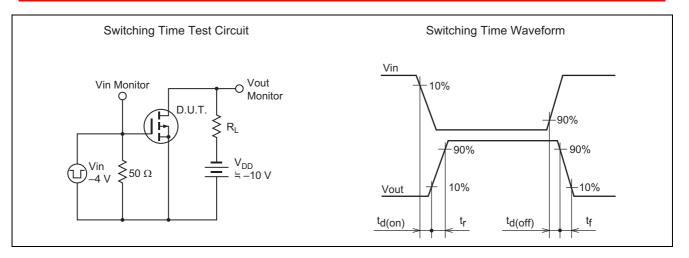






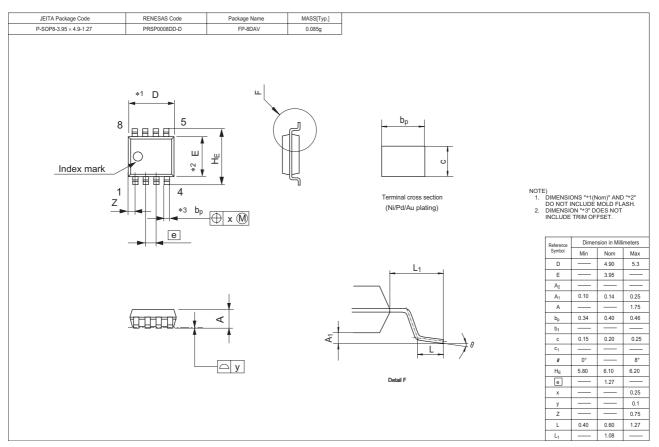


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Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT1024R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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